

Design and Implementation of Future EV, Green Energy and Power System by Using Wolfspeed SiC

 *Wolfspeed*® OCT. 2021.

AGENDA

- ❖ Wolfspeed Introduction
- ❖ Introduction of SiC
- ❖ Advantages of Silicon Carbide (SiC)
- ❖ Wolfspeed SiC Application Design
 - ❑ EV Fast Charging
 - ❑ Solar Power
 - ❑ Offline Switch Mode Power Supply
- ❖ Tips of Gate Driving with SiC MOSFETs

NEW NAME, NEW TICKER—SAME DEDICATED PARTNER

WHAT'S CHANGED

- On October 4, 2021, we officially began operating as Wolfspeed, Inc. and trading under the ticker symbol “WOLF” on the NYSE.
- This marks the culmination of our transformational journey as we now lead the industry transition from silicon to Silicon Carbide as a pure-play, global semiconductor powerhouse.

WHAT IT MEANS

- This is a natural progression that builds on our unsurpassed reputation of developing silicon carbide solutions and capitalizes on the competitive positioning the Wolfspeed brand has in the market.
- By sharpening our focus on our portfolio of silicon carbide products, we're now in the best position to lead a once-in-a-generation technology shift and create the products and materials that our customers use to power a cleaner, better future.

WOLFSPEED AT A GLANCE

Headquarters: Durham, North Carolina

Founded: 1987

Global Footprint: 17 Countries

Website: www.wolfspeed.com

Stock Symbol: WOLF

Stock Exchange: NYSE

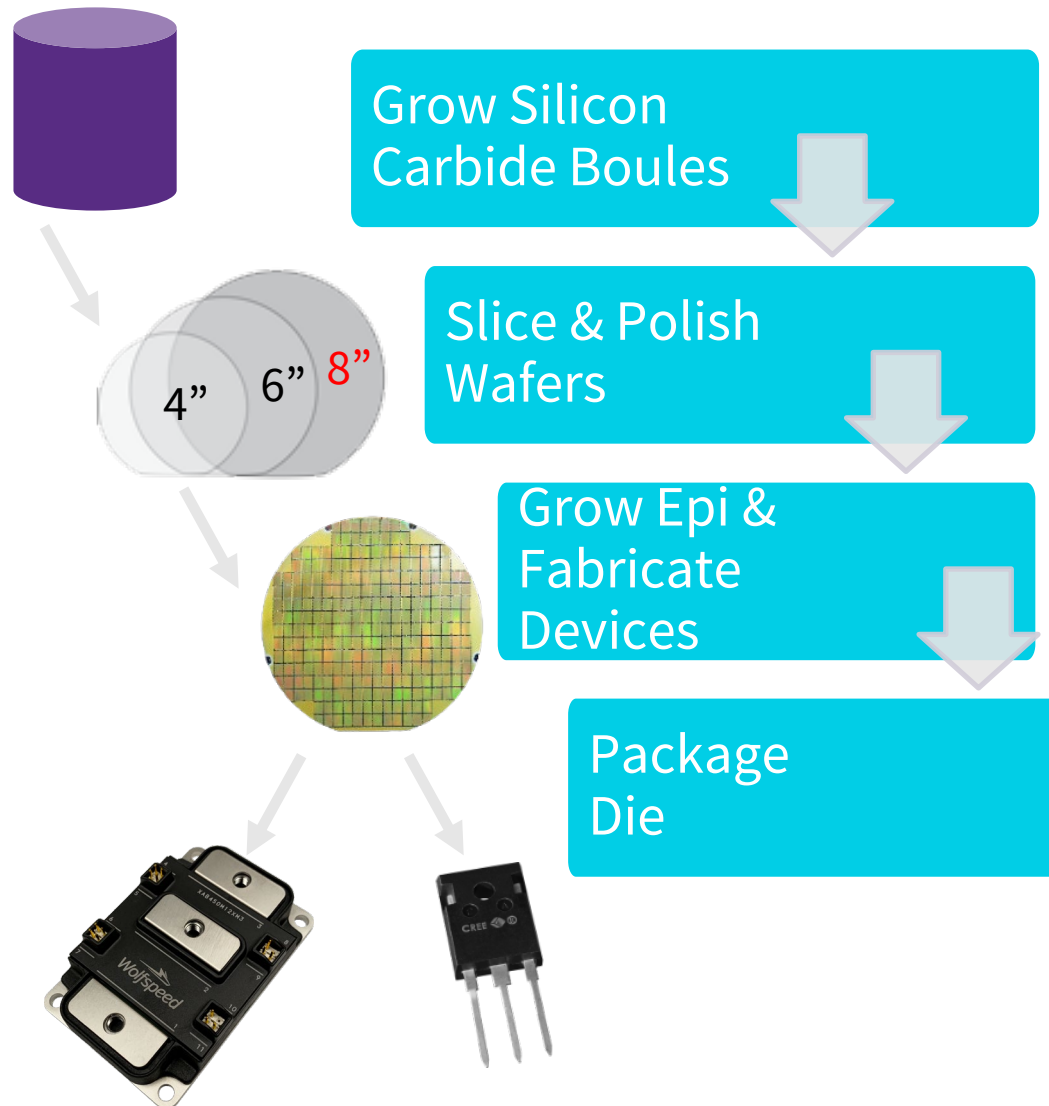
People: ~3,500 Employees

History: 30+ years of technology leadership

Revenue: \$525.6M in FY2021

Innovation: ~2,140 Issued Patents

DEEP DOMAIN EXPERTISE SETS US APART



WE ARE THE ONLY VERTICALLY-INTEGRATED POWER & RF SUPPLIER

- Global market-leading position in Silicon Carbide materials and wafers
- 30+ years of intellectual property and expertise
- Over six trillion field hours for Silicon Carbide power devices
- Thousands of customers with millions of MOSFETS and diodes in use
- Unmatched cycles of learning

WE ARE EXPERTS IN THE SCIENCE OF SILICON CARBIDE FABRICATION

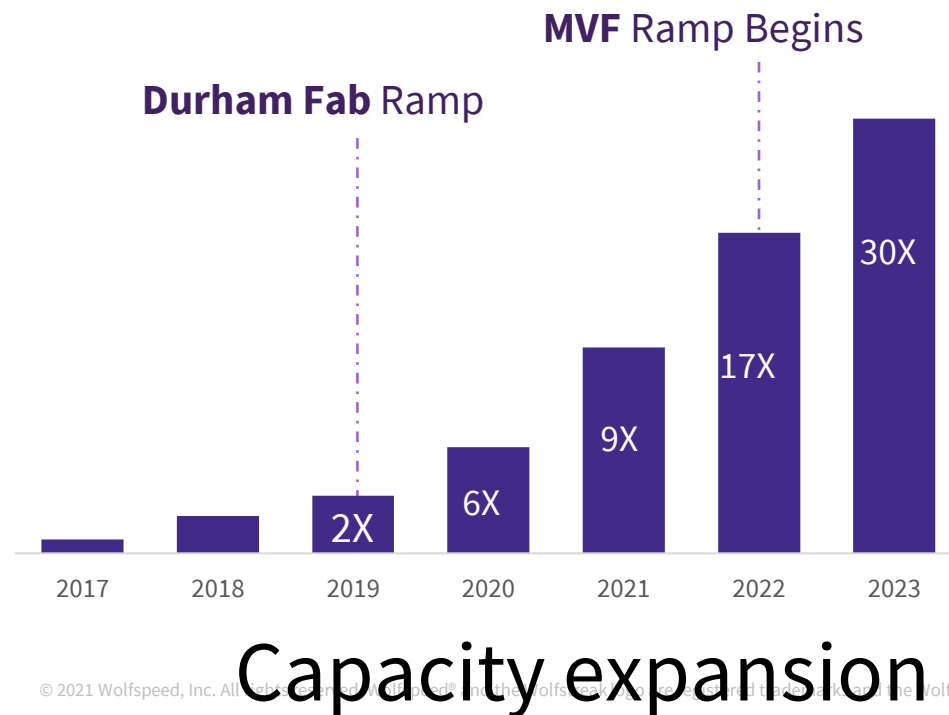
- Our team has in-depth knowledge and experience in the complex process of crystal production
- Silicon Carbide crystals require an extremely hot temperature to grow (2,500 degrees Celsius) and we've mastered control over this environment

UNSURPASSED INTELLECTUAL PROPERTY PORTFOLIO

- Our IP portfolio for GaN and Silicon Carbide devices covers a breadth and depth of high-performing, reliable products that no other company matches

BUILDING A POWERHOUSE SEMICONDUCTOR COMPANY

- Accelerating Capital **Investment** Plan
- Ramping Mohawk Valley at **200mm**
- Renaming the Company **Wolfspeed**



484,000

SQ FT STATE-OF-THE-ART
FABRICATION FACILITY

>30x

INCREASE IN SILICON
CARBIDE WAFER
FABRICATION PRODUCTION

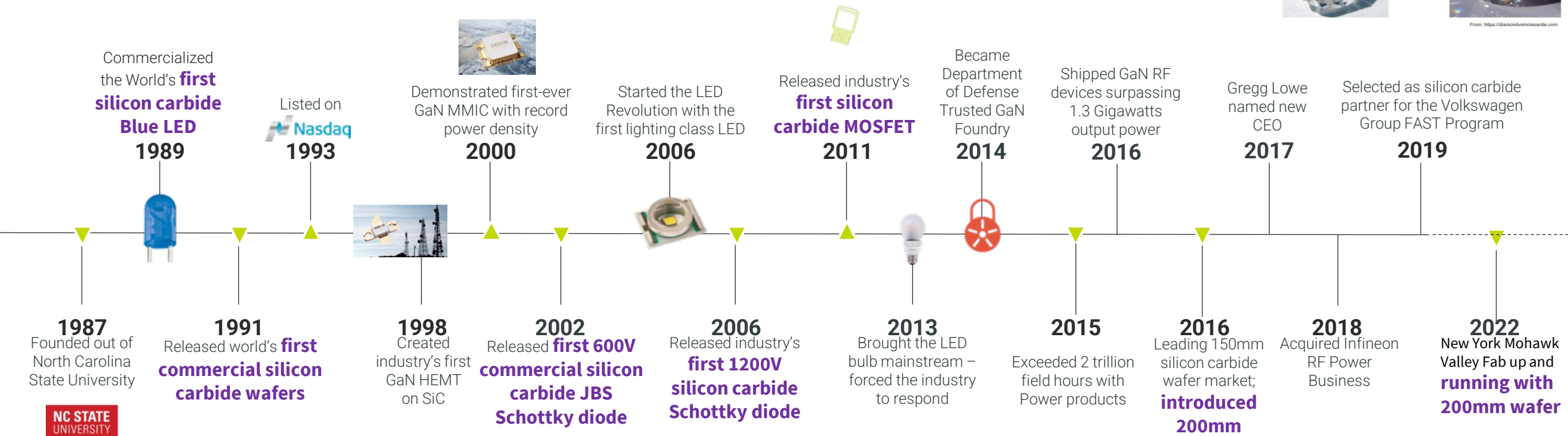
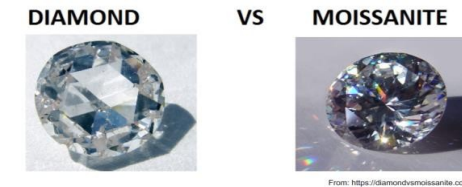
200mm

AUTOMOTIVE-QUALIFIED
PRODUCTION FACILITY

BRIEF HISTORY OF SiC AND WOLFSPEED

https://www.tf.uni-kiel.de/matwis/amat/semi_en/kap_a/advanced/ta_1_3.html

- In contrast to diamonds, **SiC** is never found on this world (and thus never became a valued gemstone in the past). Only in fragments of other worlds (i.e. **meteorites**), on occasion contain **SiC** as has been found by **Moissan** in **1905**. Mineralogists thus call "natural" **SiC** "**Moissanite**".
- In **1955**, **Lely** made the next big step in inventing the "**Lely growth method**" to grow **SiC** crystal
- 1987 Cree Research Inc.**, the first commercial supplier of **SiC** substrates, was founded



ADVANTAGES OF SILICON CARBIDE (SiC)

KEY PARAMETERS COMPARISON SI VS. SiC VS. GAN

Tj_max → Higher is better.

Robustness

Winner: **SiC**

EAS → Higher is better.

Robustness

Winner: **SiC**. **No EAS capability for GaN**

Rthjc → Lower is better.

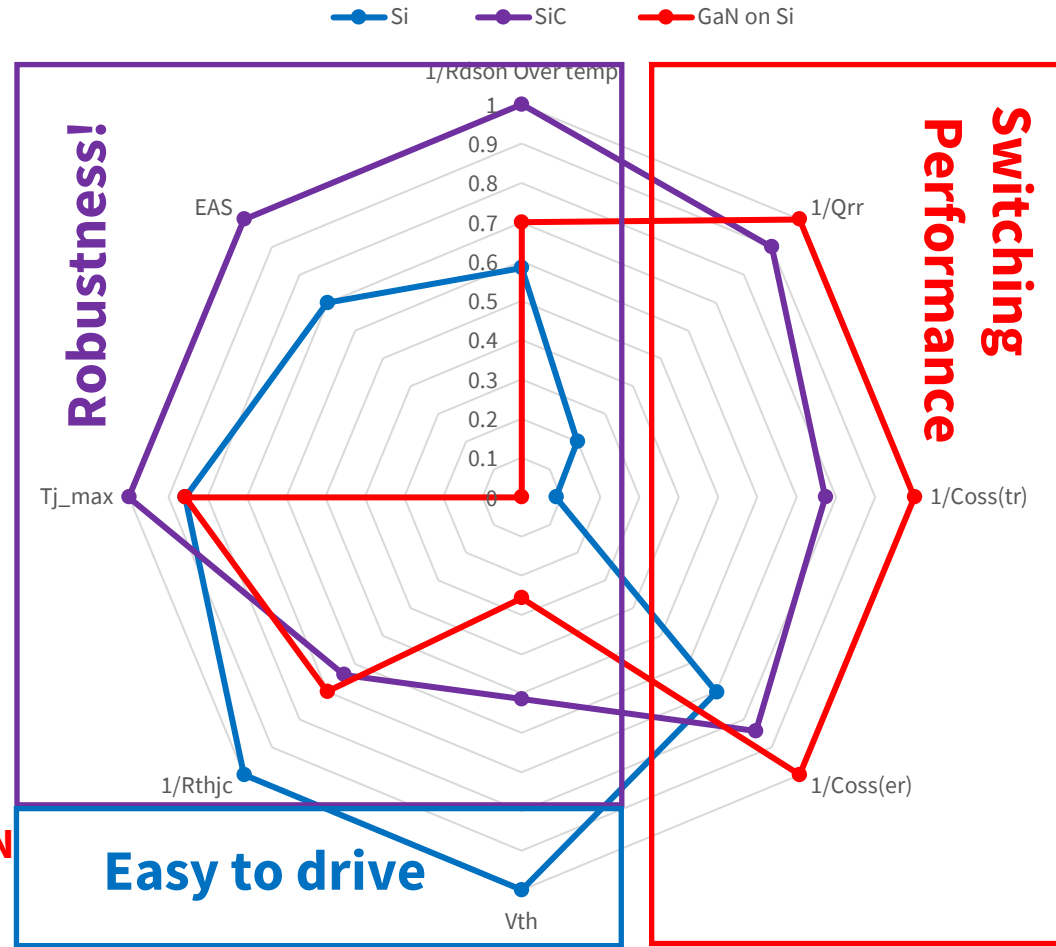
Thermal performance

Winner: **Si**

Vth → Higher is better.

Immunity to noise. Easy to drive

Winner: **Si**. **Very low Vth for GaN**



Rdson over temp → Lower is better.

Lower loss @high T → High efficiency, deliver higher power,

Winner: **SiC**

Qrr → Lower is better.

Switching loss for CCM sync rectifier

Winner: **GaN**, **SiC is close to GaN**

Coss(tr) → Lower is better.

dead time / Lm design → high frequency and efficiency

Winner: **GaN**, **SiC is close to GaN**

Coss(er) → Lower is better.

Minimum switching losses in hard-switching topologies

Winner: **GaN**, **SiC**, **Si is not too bad**

APPLICATION:

EV Fast Charging

WHAT: Fast charging DC stations: 30 min charge duration.
Bypasses OBC for rapid direct battery charging.

WHERE: PHEV, BEV battery charging 90kW – 350kW (average 160kW).

- DC charge from station to car.
- Typically today constructed from multiple 20-30kW blocks.

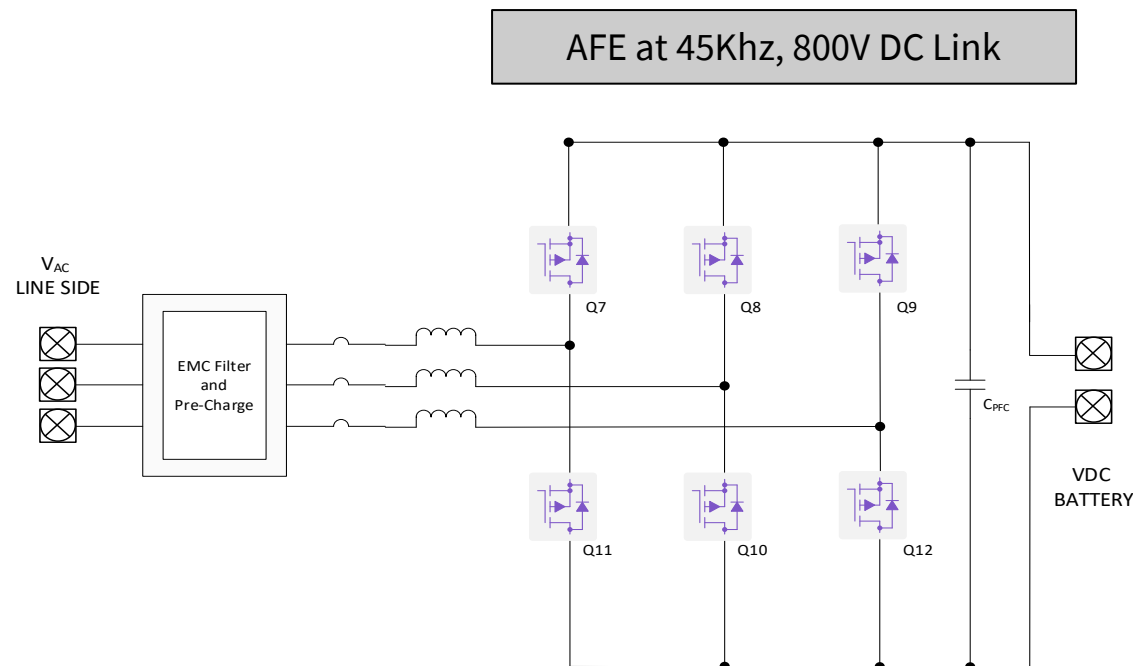
WHY: System cost, System efficiency, Power density (smaller stations), charger maintenance/up time. Future trends bidirectional energy flow

SIC ADVANTAGE:

- ~1-2% higher efficiency, 35-50% increase in power density at comparable system costs
- Less overall system cooling, smaller and cheaper mechanical housing
- Enables better Bidirectional charging for V2G / V2H



3-PHASE 2-LEVEL ACTIVE FRONT END (AFE) | BI-DIRECTIONAL



6 x 1200V 32mOhm Discrete SiC MOSFET (22kW) or
 1 x CCB021M12FM3 Wolfspeed WolfPACK(25kW) or
 2 x CCB021M12FM3 Wolfspeed WolfPACK(50kW)

BENEFITS

- 1200V SiC enables **Simple** 2-Level bidirectional AFE
- SiC enables **Smaller choke** with 2.5x Fsw
- Low component count and **Low Cost**
- **Mature** Control Scheme

CHALLENGES

- Cant reduce frequency further to balance core loss
- High DC+/DC- swing/voltage MOSFET stress , **High switching loss**
- Hard switched 2-Level topology – **EMI concerns**

Cost

Switch

IGBT

32%

SiC

62%

Choke

40%

19%

Driver

9%

9%

Thermal

19%

10%

METRIC

Fsw

IGBT

20kHz

SiC

45kHz

Power Density

3.5kW/L

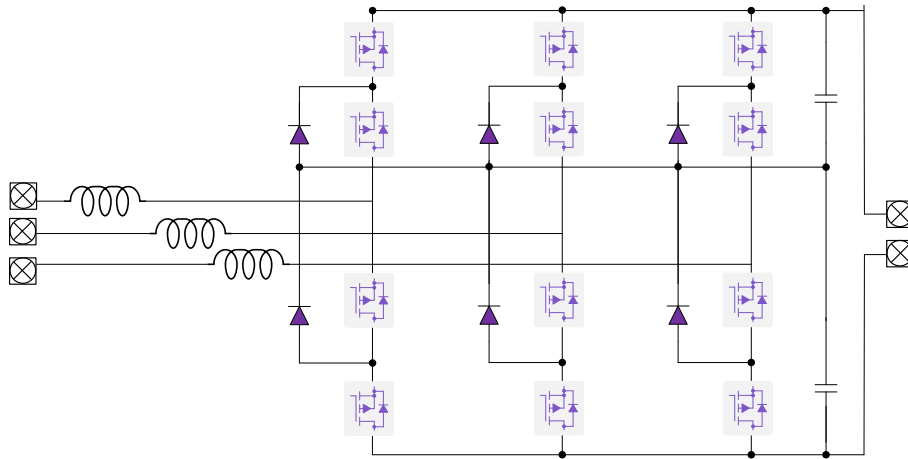
4.5kW/L

Efficiency

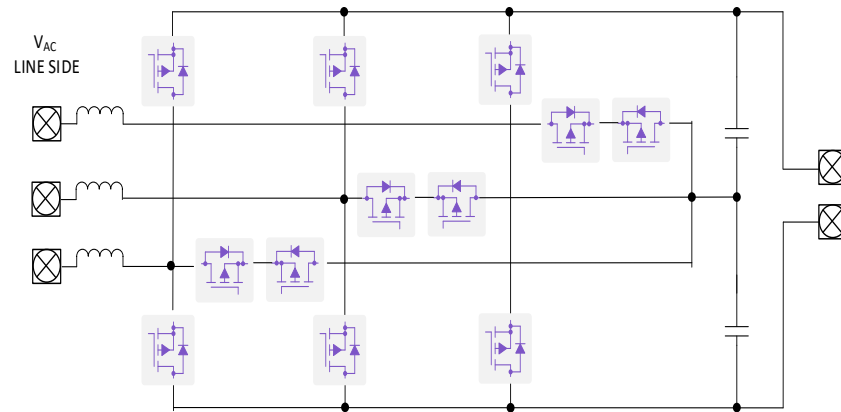
97.2%

98.2%

20-30KW A/NPC, TNPC AC-DC CONVERTER | BI-DIRECTIONAL



12x 650V SiC 25mOhm MOSFET +
6x 650V 16A SiC Schottky Diode



6x 1200V 32mOhm SiC (Outer) +
6x 650V SiC 45mOhm MOSFET (Mid)

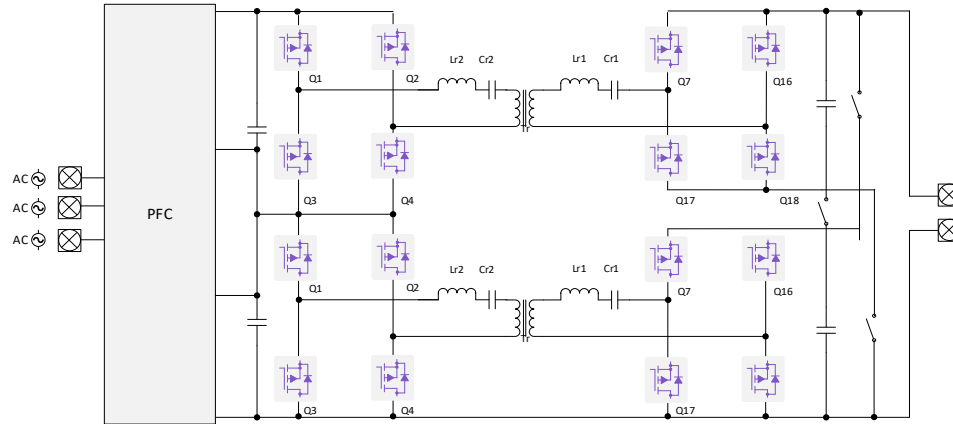
SiC BENEFITS vs Si

- Simple Si to SiC transition
- SiC Diode eliminates reverse recovery current for higher efficiency
- Lower power loss

SiC BENEFITS vs Si

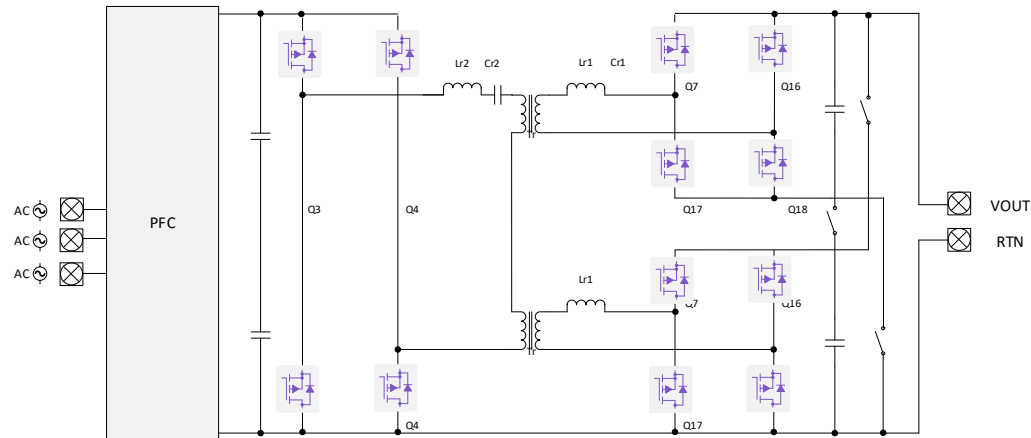
- 1200V SiC enables high frequency operation (>45kHz)
- Reduce magnetics size
- Lower power loss

20-30KW CASCADE LLC/ 2LEVEL LLC DC-DC CONVERTER | BI-DIRECTIONAL



8x 650V 45mOhm SiC MOSFET's

8x 650V 45mOhm SiC MOSFET's



4x 1200V 32mOhm SiC MOSFET or
2x CAB016M12FM3 Power Module

8x 650V 25mOhm SiC MOSFETs

SiC BENEFITS vs Si

- Simple Si to SiC transition
- SiC enables high frequency operation (up to 200kHz)
- Lower power Loss

SiC BENEFITS vs Si

- 1200V SiC enables 2 Level design
- Series LLC Transformer
- SiC enables high frequency operation (up to 200kHz)
- Lower power Loss

Wolfspeed SiC In DC Fast Charger Applications



STACKABLE POWER BLOCKS - BIDIRECTIONAL



STACKABLE POWER BLOCKS – UNIDIRECTIONAL



SUPER STATION - UNIDIRECTIONAL

20kW

30kW

50kW

100kW

300kW

600kW



Discrete Blocks (20kW) x 1

Discrete Blocks (20kW) x 3

Discrete Blocks (30kW) x 6

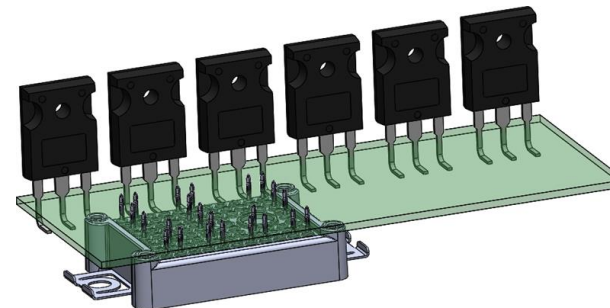
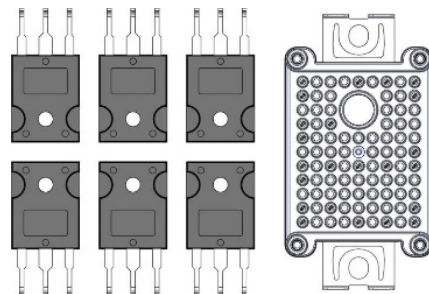
Discrete Blocks (60kW) x 6

Discrete Blocks (60kW) x 10

Module Block (25kW) x 2

Module Block (50kW) x 4

Module Block (50kW) x 8



High Power Integrated Design

APPLICATION:

Offline Switch Mode Power Supply

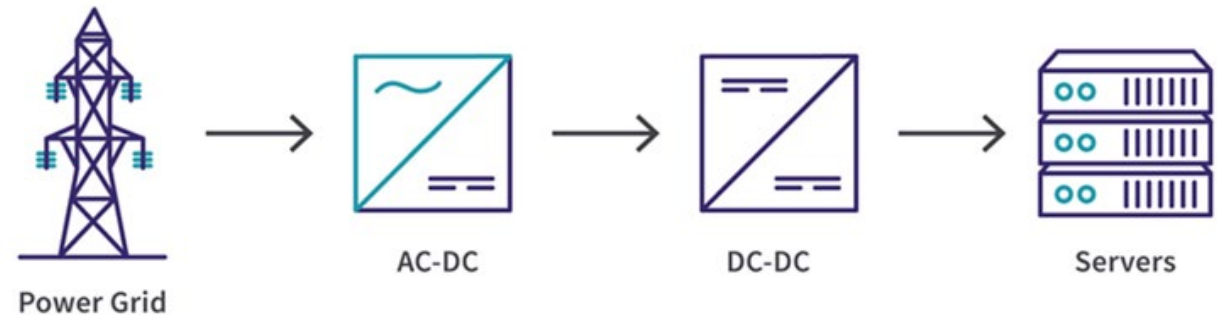
WHAT: Silicon Carbide MOSFETs and Diodes

WHERE: Offline switch mode power supplies

WHY: Maximize output while minimizing energy consumption

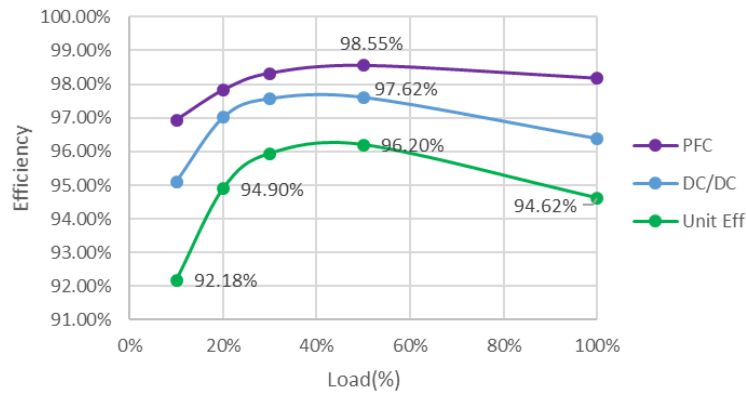
SIC ADVANTAGE:

- Increases efficiency
- Reduces size
- Superior thermals

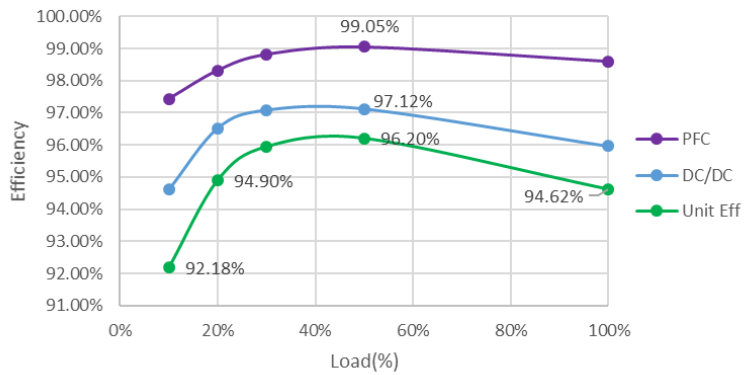


EFFICIENCY STANDARD OF SMPS FOR DATA CENTER

Typical Efficiency of Server Power Titanium



Typical Efficiency of Server Power Titanium



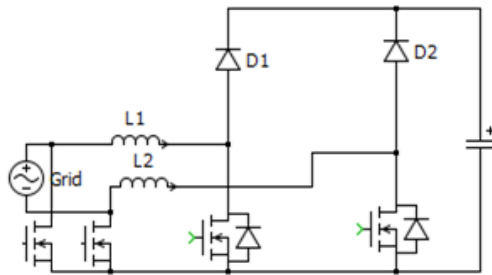
Requirement	Output/Load	Efficiency				Power Factor ¹				80PLUS	
		10%	20%	50%	100%	10%	20%	50%	100%	115V non-redundant	115V Industrial
Energy Star 3.0	multi	---	90%	92%	89%	---	0.80	0.90	0.95	Platinum	Platinum
	single ≤ 500W	---	---	---	---	---	0.80	0.95	0.95	Titanium ²	---
	500W < single ≤ 1000W	83%	90%	94%	91%	0.65	0.80	0.95	0.95	Titanium ²	---
	single > 1000W	---	---	---	---	0.80	0.90	0.95	0.95	Titanium ²	---
Requirement	Output/Load	10%	20%	50%	100%	10%	20%	50%	100%	230V non-redundant	230V redundant
Lot 9 (1-Mar-2020)	multi	---	88%	92%	88%	---	---	0.90	---	Gold	Gold
	single	---	90%	94%	91%	---	---	0.95	---	Platinum ²	Platinum
Lot 9 (1-Jan-2023)	multi	---	90%	94%	91%	---	---	0.95	---	Platinum ²	Platinum
	single	90%	94%	96%	91%	---	---	0.95	---	Titanium	Titanium

80 Plus test type Percentage of rated load	Icon	115 V internal non-redundant				230 V internal redundant				230 V EU internal non-redundant			
		10%	20%	50%	100%	10%	20%	50%	100%	10%	20%	50%	100%
80 Plus			80%	80%	80%						82%	85%	82%
80 Plus Bronze			82%	85%	82%		81%	85%	81%		85%	88%	85%
80 Plus Silver			85%	88%	85%		85%	89%	85%		87%	90%	87%
80 Plus Gold			87%	90%	87%		88%	92%	88%		90%	92%	89%
80 Plus Platinum			90%	92%	89%		90%	94%	91%		92%	94%	90%
80 Plus Titanium		90%	92%	94%	90%	90%	94%	96%	91%	90%	94%	96%	94%

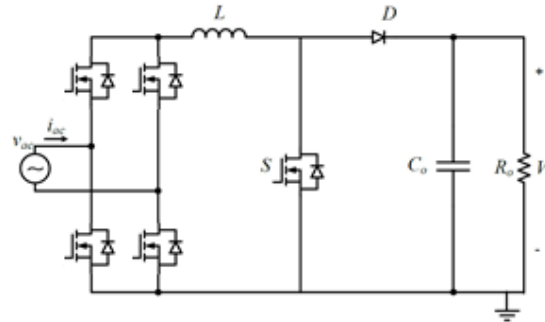
>98.5% PFC peak efficiency is required for 80plus Titanium applications. Two approaches

TOPOLOGIES OF PFC

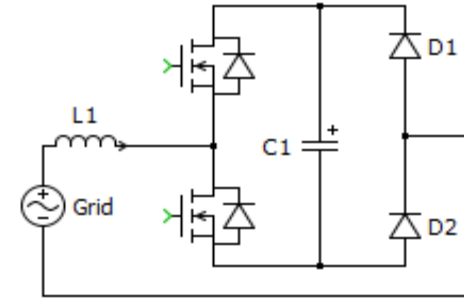
Dual Boost Bridgeless PFC



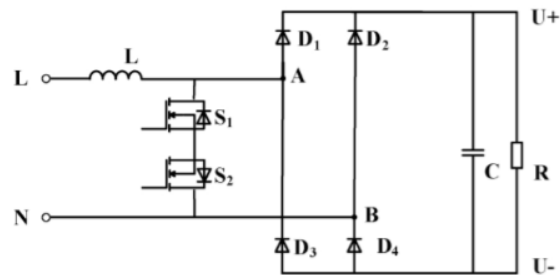
Active Bridge CCM PFC



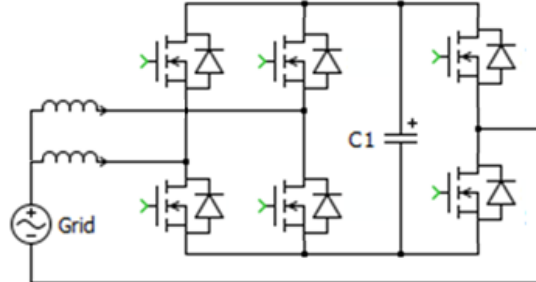
Totem Pole Semi-Bridgeless CCM PFC



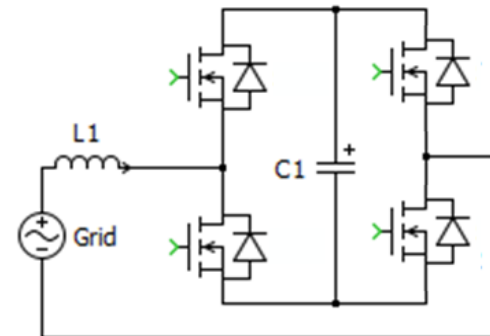
H Bridge PFC



CrM Interleave Totem Pole Bridgeless PFC



Totem Pole Bridgeless CCM PFC



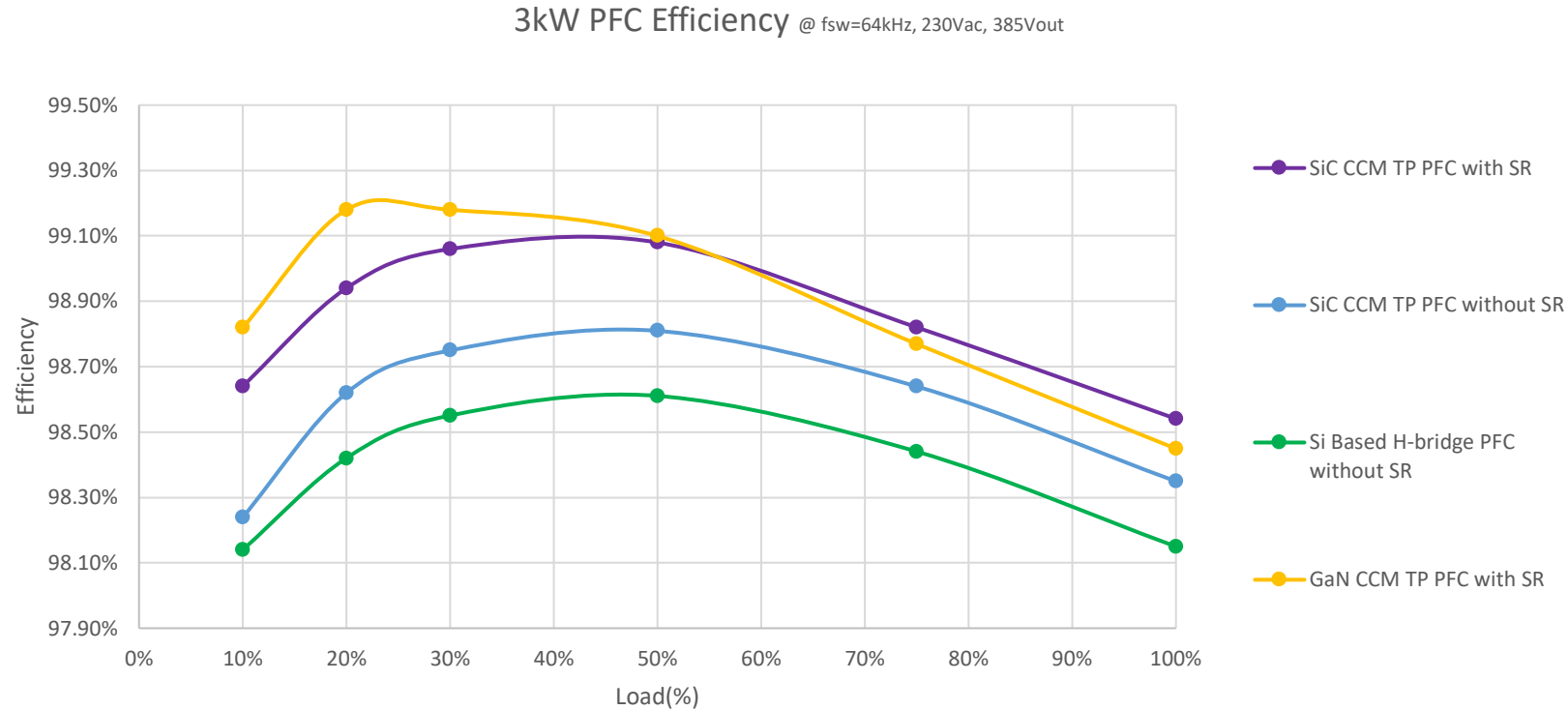
PFC topologies before the adoption of WBG device

COMPARISON OF BRIDGE-LESS PFC SOLUTIONS

	# PFC Choke	# of Power Switch	Power density	Peak Efficiency	Cost
Si Conventional CCM PFC	1	3*	Medium	98.3%	Low
Si Active Bridge CCM PFC	1	6	Medium	98.9%	Highest
Si Dual Boost Bridgeless PFC	2	6	Lower	98.6%	Medium
Si Dual Boost Bridgeless PFC SR	2	6	Lower	98.9%	High
Si H Bridge PFC	1	6	High	98.6%	Medium
Si CrM Totem Pole Bridgeless PFC	2	6	Medium	98.9%	Highest
SiC CCM Totem Pole Semi-BL PFC	1	4	Highest	98.8%	Medium
*SiC CCM Totem Pole bridgeless PFC	1	4	Highest	99.1%	High
GaN CCM Totem Pole Semi-BL PFC	1	4	Highest	98.8%	High
GaN CCM Totem Pole bridgeless PFC	1	4	Highest	99.2%	Highest
GaN CRM Totem Pole bridgeless PFC	2	6	Medium	99.1%	Highest

- SiC based CCM totem pole PFC can have higher efficiency and higher power density than Si based H-bridge PFC with similar or even lower cost.

EFFICIENCY COMPARISON OF PFC SOLUTIONS



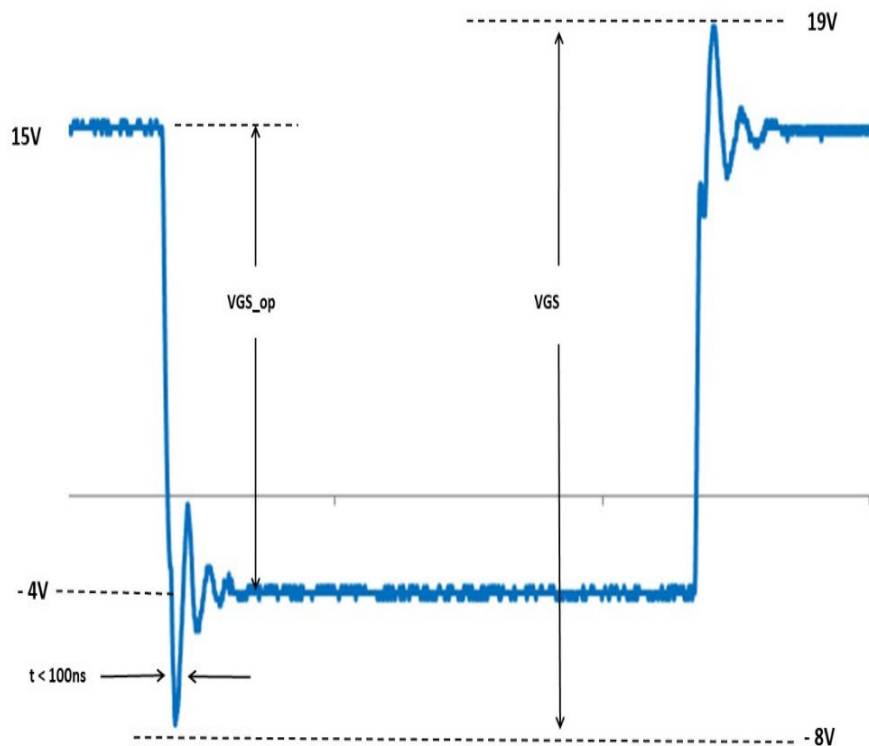
- SiC based CCM totem pole PFC can have higher efficiency than Si based H-bridge PFC.
 - GaN has efficiency advantage at light load. But with much higher $R_{ds(on)}$ over temperature, the efficiency and power delivery capability is compromised at higher power.
- SiC is the clear choice for the power components for Totem pole PFC especially for high reliability applications.

Tips of Gate Driving with SiC MOSFETs



GATE DRIVE VOLTAGE LEVEL

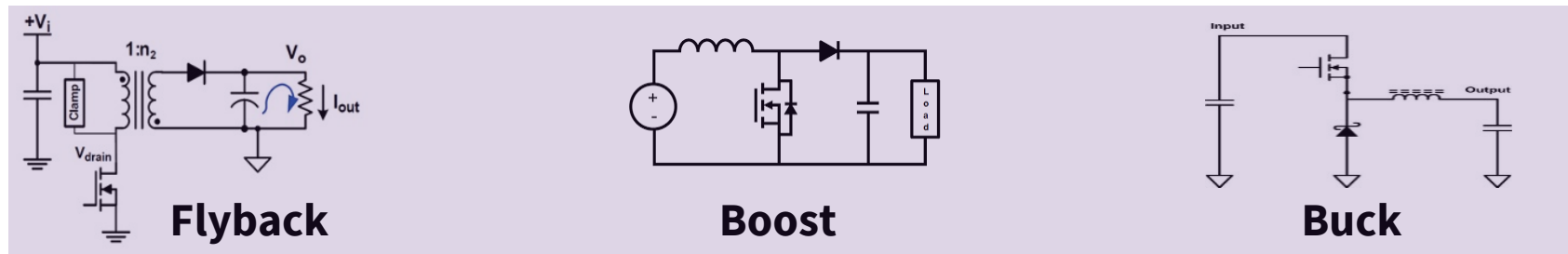
V_{GS}	Gate - Source voltage (Under transient events < 100 ns)	-8/+19	V	Fig. 29
V_{GS_op}	Gate - Source voltage (Recommended operating range)	-4/+15	V	



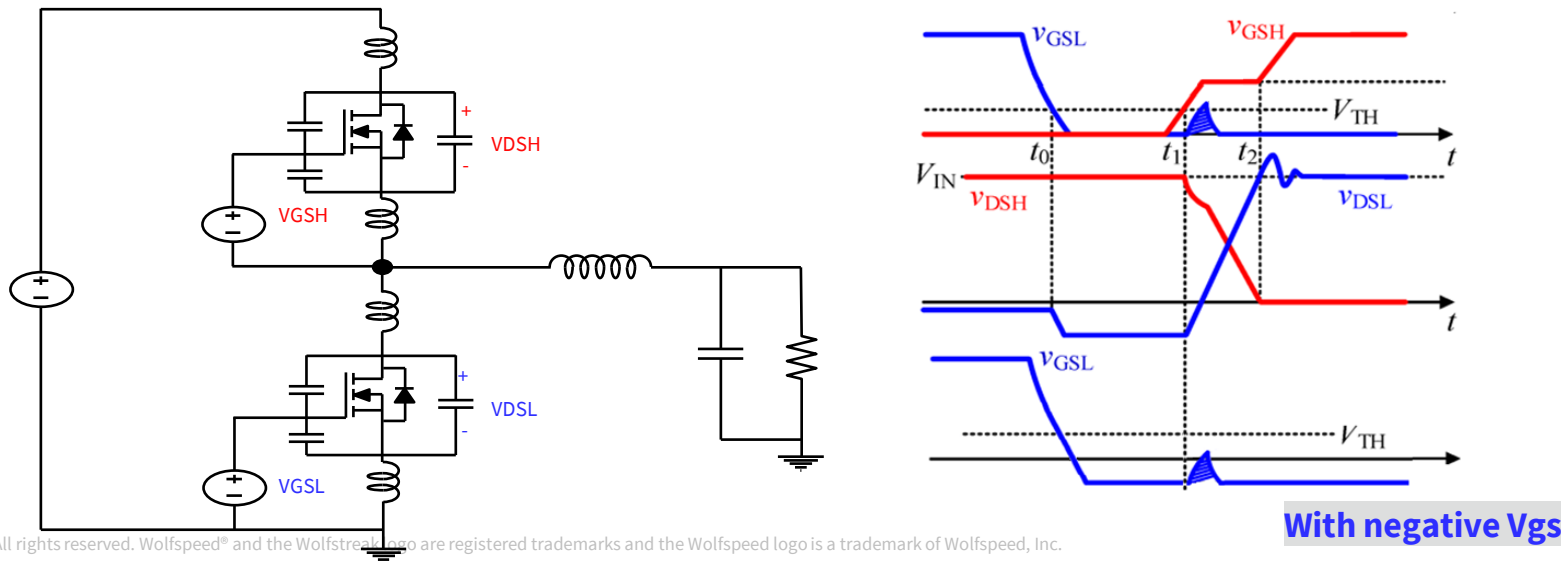
- The first V_{GS} rating is the absolute max rating. The max V_{GS} rating allows for ringing and overshoots that will be superimposed on top of the continuous gate drive voltage.
- The second V_{GS_OP} rating is the recommended max operating setting for turn-on and turn-off voltage. The max nominal power supply voltage for turn-on is recommended at 15V, and -4V for turn-off. This is recommended value for safe operation and long term reliability.
- For nominal -4V, if considering tolerance +/-5%, the range is -4.2V/-3.8V. For very common -3V, the range will be -3.15V/-2.85V.
- For nominal +15V, if considering tolerance +/-5%, the range is 15.75V/14.25V.
- **Actually, if the layout is optimized, the negative gate bias can be -3V or -2V as long as there is no false turn-on. The benefit of using lower negative gate bias voltage is the V_f of body diode is lower.**

WHY NEGATIVE DRIVING VOLTAGE?

- Wolfspeed Gen3 SiC MOSFETs can safely operate at +15V/0V condition. Adding negative gate bias improves noise immunity, avoiding false turn-on in half bridge configuration.
- In single end power converter such as Flyback, Boost, or Buck converter, it is possible to use 0V turn-off voltage:

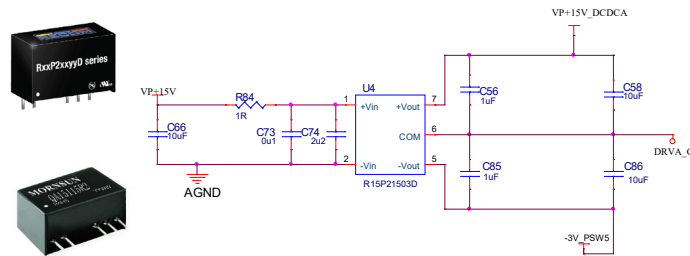


- It is recommended to use negative voltage for Totem Pole half bridge topology due to cross talk

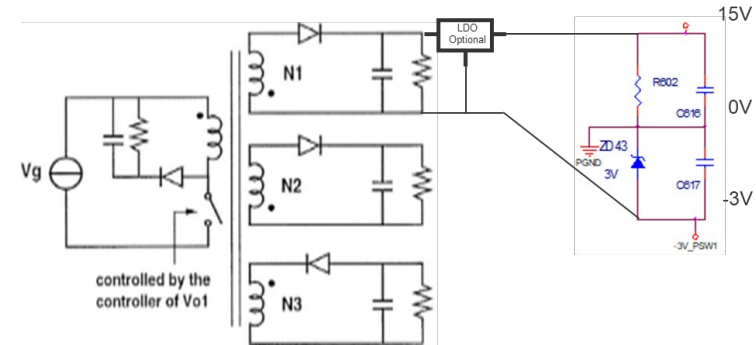


POSITIVE & NEGATIVE GATE DRIVER VOLTAGE SOLUTIONS

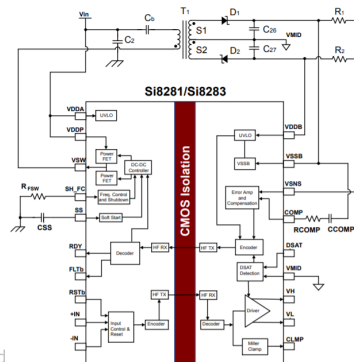
- OPTION 1 – Integrated solution
 - Dedicated +15V/-3V power supply



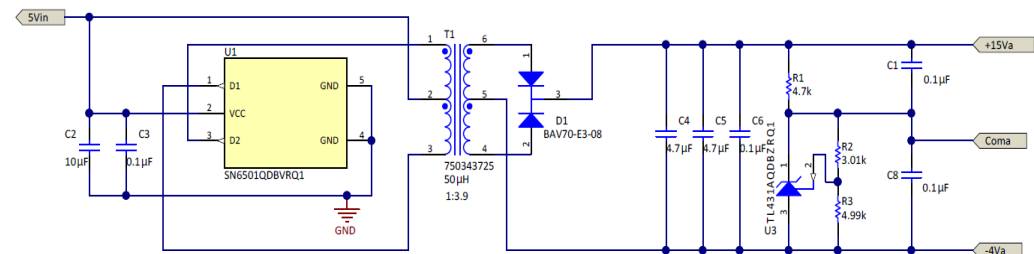
- OPTION 2 – Discrete solution
 - 18V multi-outputs Aux power supply. Generate -3V by resistor and Zener diode



- OPTION 3 – On board In the driver
 - Gate driver IC with built in DC/DC controller (e.g. Si8281)

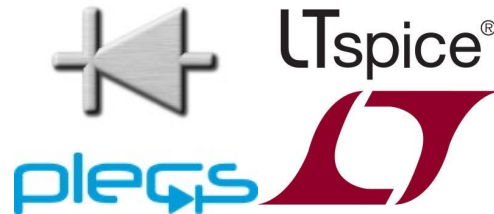


- OPTION 4 – Build your own
 - Push-Pull Circuit from Texas Instruments TIDA-01605



DESIGN SUPPORT

Electrical simulation



<https://www.wolfspeed.com/speedfit>

<https://go.wolfspeed.com/all-models>



Reference designs



<https://www.wolfspeed.com/power/products/reference-designs>



Application	Reference design name	Topology
Automotive	<u>6.6 kW Bi-Directional EV On-Board Charger</u>	AC to DC, DC to AC
Automotive	<u>22kW Bi-directional High Efficiency DC/DC Converter</u>	Bi-Directional DC to DC
Automotive & Renewable Energy	<u>22kW Bi-directional High Efficiency Active Front End (AFE) Converter</u>	Bi-Directional AC to DC
Renewable Energy	<u>60 kW Interleaved Boost Converter</u>	DC to DC
Server Power supply	<u>2.2 kW High Efficiency (80+ Titanium) Bridgeless Totem-Pole PFC with SiC MOSFET</u>	AC to DC
Server Power supply	<u>6.6 kW High Frequency DC-DC Converter</u>	DC to DC



THANK YOU